6 4 3 2 1 8 INTEL MWG PCB STACKUP JACKSON PEAK 2 LAYER ATTRIBUTE MATERIAL THICKNESS 1 H ZO --> 10Z 1.9 SIGNAL G2532204 7 2116+1080 2 GND 10Z 1.2 IEEE 802.11N HALF MINI CARD PCI EXPRESS CORE 20 3 10Z 1.2 MIX 2116+1080 7 4 SIGNAL H ZO --> 10Z 1.9 TOTAL THICKNESS 40.2 FINAL THICKNESS 41.2 LAST UDPATED: JUL. 19, 2011 CONTENTS: PAGE 1) TITLE PAGE 2) HALF MINI CARD EDGE CONNECTOR AND EEPROM PAGE 3) RP-M BIAS NETWORK PAGE 4) RP-M BB & PCIE PAGE 5) RP2-R BIAS NETWORK PAGE 6) RP2-R RF/BB, DIGITAL AND CLK Tue Jul 19 09:15:22 2011 G2532204 PAGE 7) RP2-R BT SECTION ENG. NAME TITLE PAGE 8) FRONT END - CHAIN A JACKSON PEAK 2 TAL SHOSHANA PAGE 9) FRONT END - CHAIN B PAGE REV INTEL 01 1 OF 10 CONFIDENTIAL 3 8 6 4 2

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